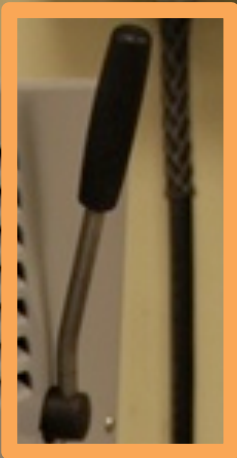


Automatic head, information display and machine setup (pg 2)



Fixing lever (pg4)

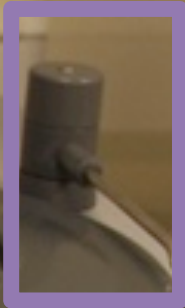
Water knob (pg 3)



Power Switch on back

Sample Holder (pg4)

Water knob (pg3)



grinding only

Grinding Side

polishing only

Polishing Side

Please see MSE Tech Staff for replacement consumables.
#2
SAPHIR 530

When finishing your time on the ATM Grinder/Polisher see Tech Staff to make sure the machine is clean.
Thanks,
MSE Technical Staff



Emergency Stop Button

Time

Force

Rotational speed (rev/min)

Working time

01:00 min

F ↓ 25 N

190 U/min

1. Water rinse: On or Off for program

2. Center or Single Pressure mode

3. Contra or Complimentary rotation

Adjust wheel: to make adjustments on desired values in the display

UP or DOWN IN SOFTWARE

WATER

LOWER AUTOMATIC HEAD

Double click to start running machine

Grinding Steps

(use program #4 for lab class – AL GR NO ED MSE)
(water flow decreased over finer grit paper)

- 22N force, with water, 300rpm, complementary direction
- 240 GRIT – **grind until all scratches from cutoff saw are removed**
- 320 GRIT – 1 minute
- 400 GRIT – 1minute
- 600 GRIT – 1 minute
- 1200 GRIT – 1 minute



Polishing Steps

(use program #5 for lab class – AL PO NO ED MSE)

- 22N force, without water, 150rpm, complementary direction
- **Spray solution sparingly** (approx. every 1 minute)
- 6micron polylube diamond, run for 5 minutes
- 3micron polylube diamond, run for 5 minutes



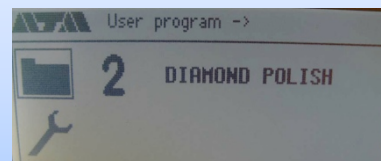
0.03 micron Colloidal Silica Final Polishing Step

(use program#6 for lab class - AL SI NO ED MSE)

- Mix the solution: 5mL Colloidal Silica 5mL water (**poured a little every 10seconds**)
- 20N force, with water (off of pad), 150rpm, contra direction
- run for 2 minutes, last 20 seconds with water on pad



To access the “User program” tab, scroll up above Time control or down below rotation control



Consumables are for MSE classes only!

- Found in drawers underneath machines
- If containers are empty, please see MSE tech staff



- Cleanup and put away any unused consumables and discard any used grinding paper
- Use appropriate grinding\polishing side to avoid contamination
- **Do not rinse the polishing** cloths after using

For Sample preparation, please see:

For the cutoff saw:

- LECO MSX205 abrasive cutoff saw SOP

For the band saw:

- DoAll Band saw SOP

For the mounting press:

- LECO PR-15 mounting press SOP

For additional background on metallographic preparation see pdf by Donald Zipperian posted on the SOP online

Most of the time automatic head is setup for "single sample" holder. To change this, please see MSE tech staff.



There are two forms of sample holders, center and single sample pressure modes:

- If 4 or less samples, then use the **single sample holder**
- If 5 samples, then use the **center mounted sample holder**

In between each grinding and polishing step, please thoroughly clean:

The samples

- For grinding: rinse with water
- For polishing: rinse with water, then a soapy cotton ball, then water, then ethanol

The wheel and surrounding area:

- Use the water rinse and remove any excess debris with a paper towel.

The sample holder:

- Use a paper towel

Repeat process when completely finished